FY2026 First Quarter (Ended May 31, 2026) Financial Briefing

July 9, 2026

RORZE CORPORATION

(Code : 6323)

https://www.rorze.com/ir

Disclaimer

Regarding forward-looking statements

The business forecasts and other forward-looking statements contained in this document are based on judgments made in accordance with information currently available for our company and do not constitute a guarantee or promise of the accuracy or completeness of such information. The forecast is also subject to change without notice due to changes in economic conditions, industry competition, markets and other systems.

Data included in this document are stated as follows

JPY values : Rounded down to the nearest unit

Percentages : Rounded to the nearest unit after calculated in units of 1 JPY

Fiscal year : Refer to the "fiscal year ended February 28, 2027" as "FY2026" or "FY'26,"

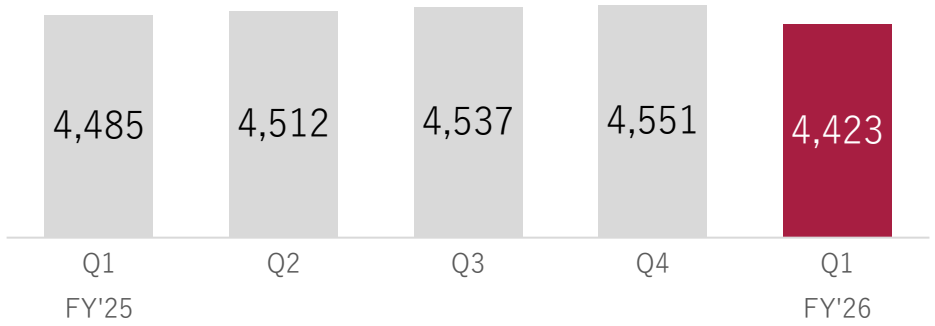
Accounting period : The accounting periods of the consolidated, head office, and domestic and overseas subsidiaries are as follows:

	Q1 (1st Quarter)	Q2 (2nd Quarter)	Q3 (3rd Quarter)	Q4 (4th Quarter)	Full-year
Consolidated・RORZE ・Domestic subsidiaries	Mar.～May.	Jun.～Aug.	Sep.～Nov.	Dec.～ The following Feb.	Mar.～ The following Feb.
Overseas subsidiaries	Jan.～Mar.	Apr.～Jun.	Jul.～Sep.	Oct.～Dec.	Jan.～Dec.

Company Profile

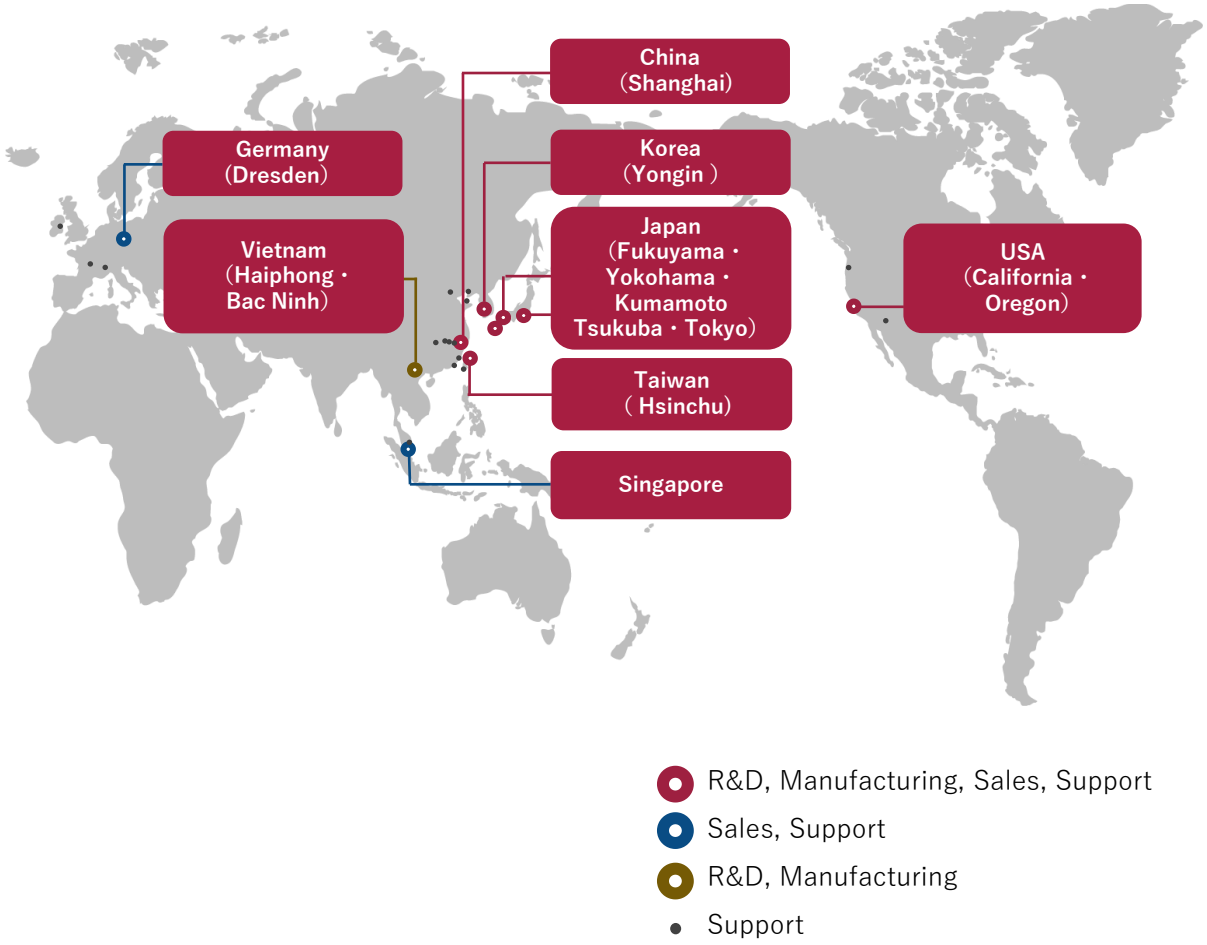
Name	RORZE CORPORATION
Listed Market	Tokyo Stock Exchange Prime Market (Securities code：6323)
Head Office	Kannabe-cho, Fukuyama-shi, Hiroshima
Establishment	March 30, 1985
Capital	982 million JPY
Business	Development, design, manufacturing, and sales of automation system for semiconductor/FPD production and life science automation products
Employees※	Consolidated： 4,423　Non-consolidated： 374（As of May 31, 2026）
Locations	Japan　: Fukuyama, Yokohama, Kumamoto, Tsukuba and Tokyo Overseas : USA, Vietnam, Taiwan, Korea, Singapore, China , Germany and France

Number of employees (Consolidated) ※



※ The number of employees includes the annual average headcount of temporary and rehired employees

Global Network



FY2026 First Quarter (March 1 ～May 31, 2026) Consolidated Business Results

Summary of Q1 FY2026

Q1 Consolidated Results (March 1 – May 31, 2026)

Net sales

37,206 million JPY

YoY +12.5%

Operating profit

10,230 million JPY

Operating profit margin 27.5%

YoY +21.2%

Ordinary profit

10,938 million JPY

Ordinary profit margin 29.4%

YoY +51.1%

Profit attributable to owners of parent

8,210 million JPY

Net profit margin 22.1%

YoY +56.0%

Record-High Net Sales

- Semi sales reached a record high of 30.2 billion JPY
- Sales increased year on year across all product categories

Achieved High Profitability

- Sales growth expanded profit, and foreign exchange gains under the weaker yen further increased profit
- Operating profit margin reached 27.5%, and ordinary profit margin reached 29.4%, achieving high profitability

Record-High Orders

- Semi orders reached a record high of 42.0 billion JPY, 1.9x YoY
- Order backlog expanded significantly to 62.2 billion JPY

Consolidated Business Results

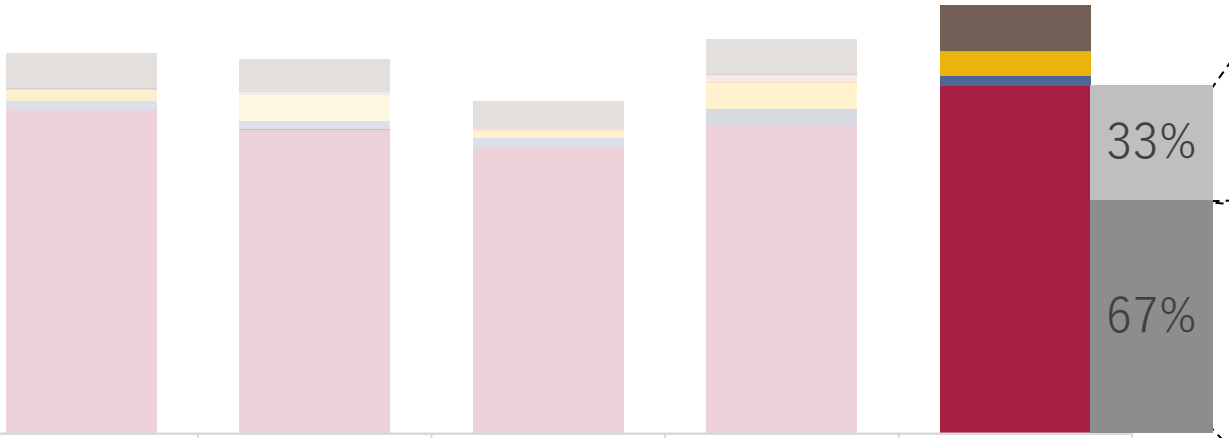
- The favorable business environment continued as the widespread adoption and expanding use of generative AI drove higher semiconductor capital investment
- Net sales reached a record high, resulting in increased revenue and profit
- All business segments, including FPD and Analysis device, recorded sales growth
- Higher sales and foreign exchange effects drove significant growth in operating profit, ordinary profit and net profit

(Million JPY)

	FY'26 Q1	FY'25 Q1	YoY
Net sales	37,206	33,061	112.5%
Semi	30,239	28,230	107.1%
Analysis device	890	660	134.9%
FPD	2,032	1,001	202.9%
Life science	131	110	118.8%
Service/Parts etc.	3,913	3,058	127.9%
Operating profit	10,230	8,441	121.2%
Ordinary profit	10,938	7,241	151.1%
Profit attributable to owners of parent	8,210	5,263	156.0%
Exchange rate(JPY/USD)	156	152	—

Quarterly Sales Trends

- Quarterly net sales reached a record high.
- Service/Parts increased as equipment sales growth expanded maintenance parts and service-related sales, mainly in Taiwan and USA
- The share of Semi sales to end users increased, led by higher sales to Taiwanese foundries



(Million JPY)	Q1 FY'25	Q2	Q3	Q4	Q1 FY'26
Service/Parts etc.	3,058	2,827	2,424	3,084	3,913
Life science	110	255	103	732	131
FPD	1,001	2,257	690	2,348	2,032
Analysis device	660	780	769	1,344	890
Semi	28,230	26,420	24,893	26,800	30,239

End-user

N2 Purge Wafer Stocker

Wafer Sorter

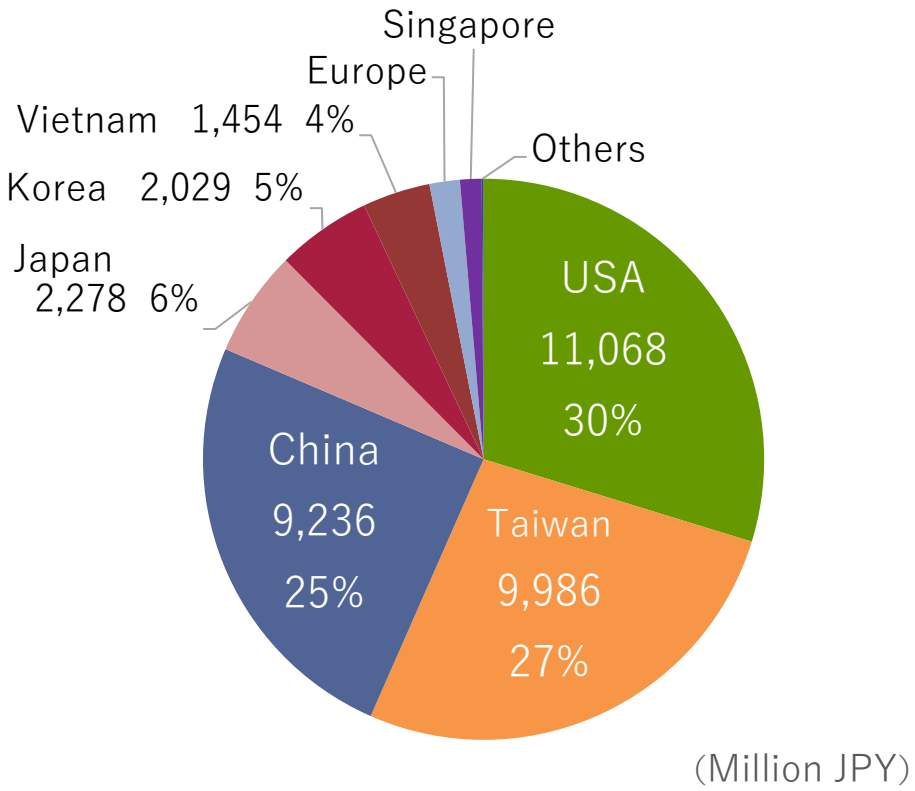
Equipment manufacturer

EFEM

Vacuum Platform

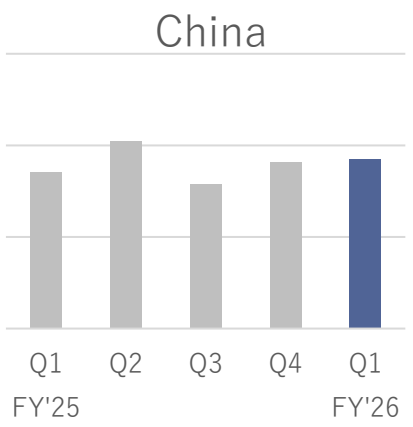
Net sales by regions

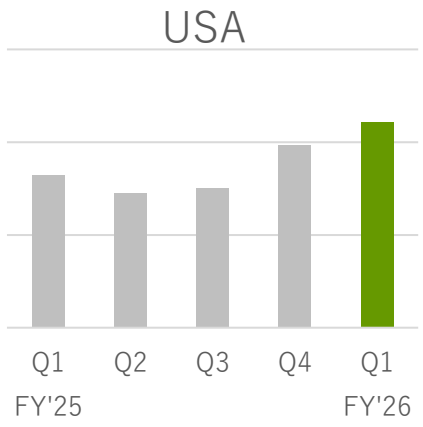
- Quarterly sales in USA and Taiwan reached record highs, supported by higher sales to major customers
- Sales to China also continued to increase

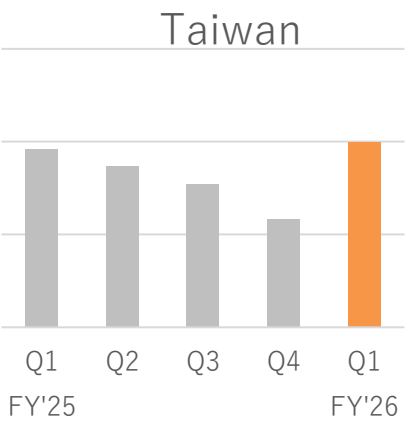


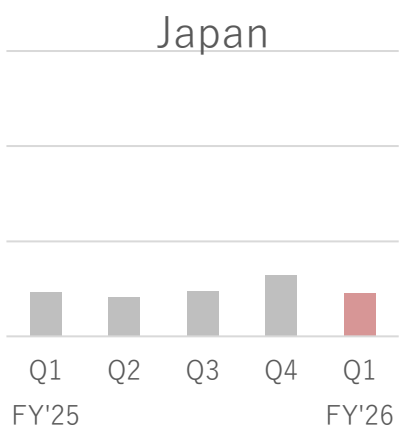
(Million JPY)

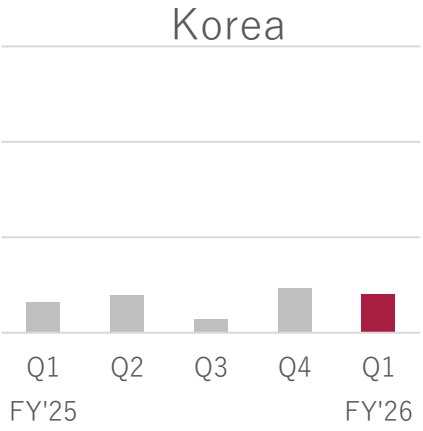
※ “Net sales by region” is calculated based on the location of each customer’s head quarter

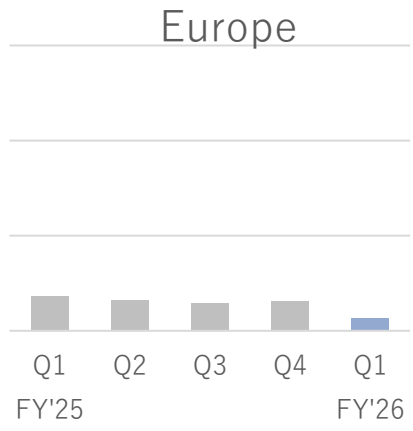








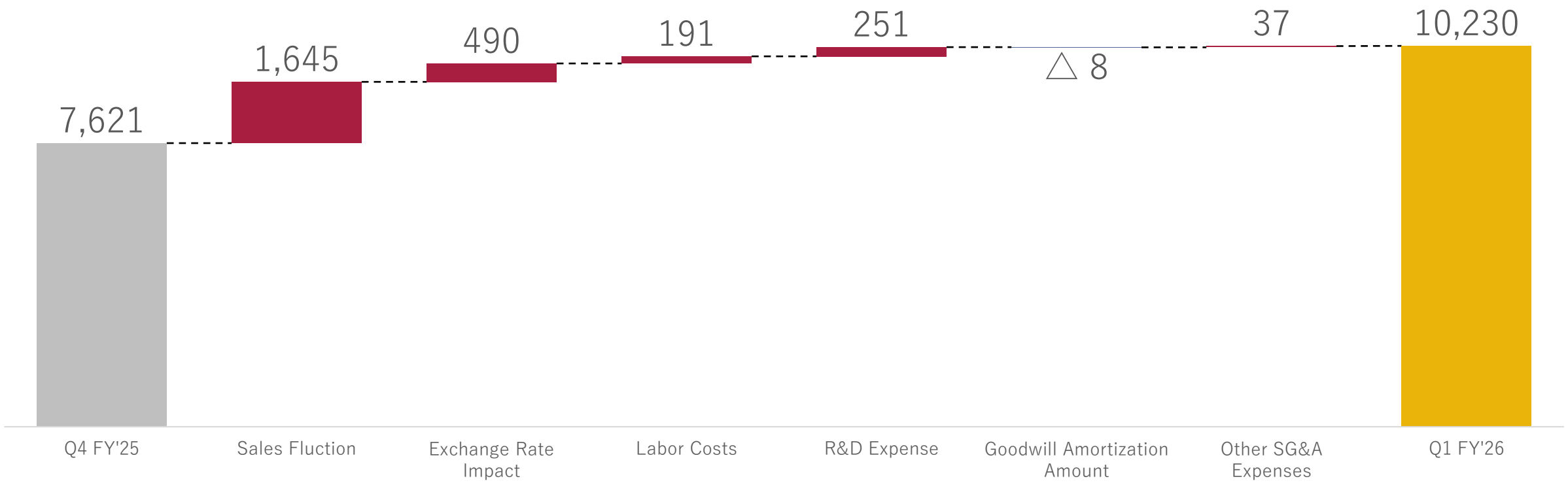




Operating profit

- Higher sales, mainly in Semi, and the weaker yen drove operating profit to a record quarterly high

(Million JPY)

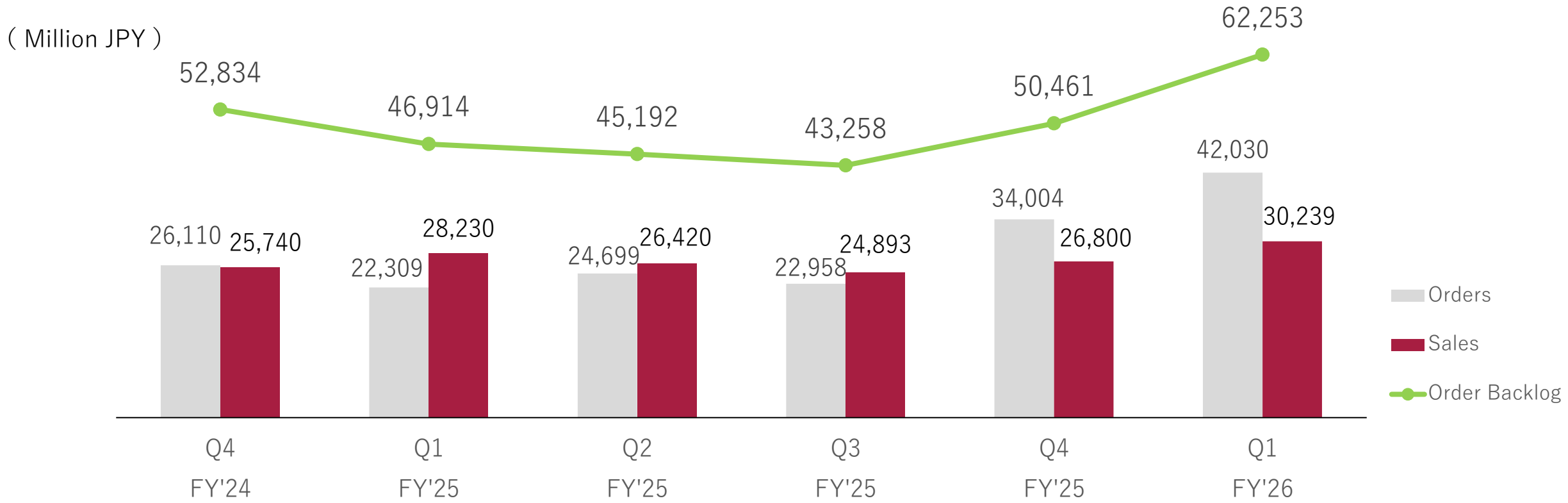


※ The impact of Nanoverse on consolidated operating profit（Million JPY）:
Labor Costs 470, R&D Expense 31, Goodwill amortization amount 738, Other SG&A Expense 319

Trends in Orders, Sales and Backlog

Semi

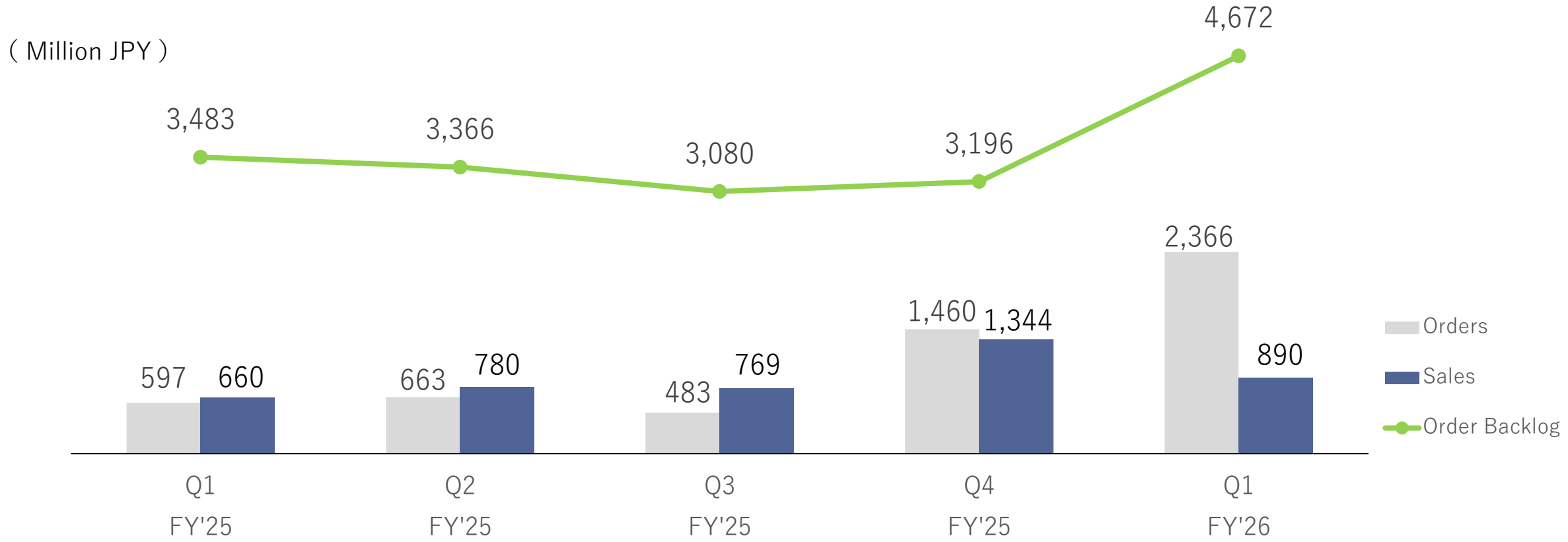
- Order amount rose significantly by 8 billion JPY QoQ to 42 billion JPY, reaching a record high for the second consecutive quarter
- Orders from Taiwan declined as a reactionary drop from the previous quarter, while China and USA increased significantly



Trends in Orders, Sales and Backlog

Analysis Device

- Order amount increased 0.9 billion JPY QoQ to 2.3 billion JPY, while order backlog expanded to 4.7 billion JPY
- Orders increased from China and Europe

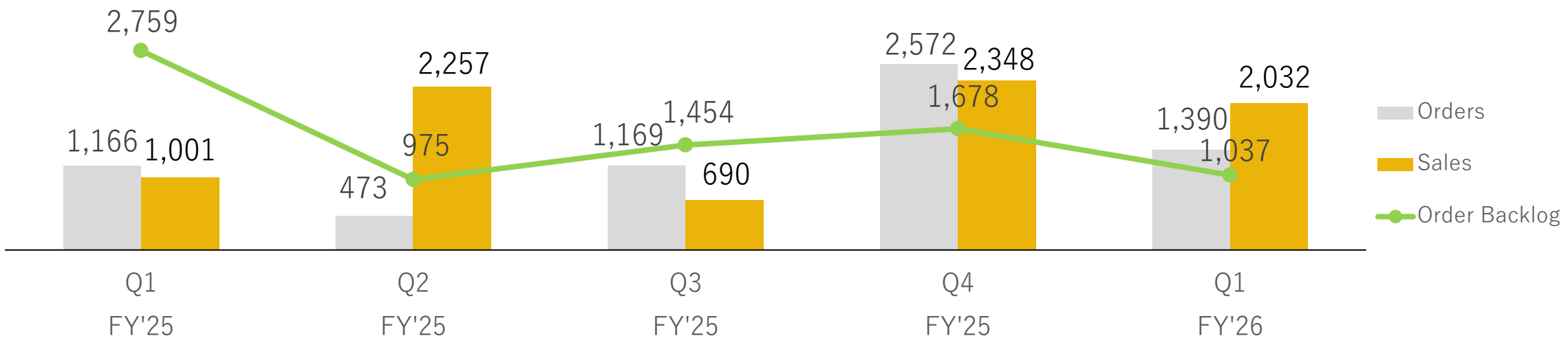


Trends in Orders, Sales and Backlog

FPD

- FPD sales remained at 2.0 billion JPY, supported mainly by automation line for FPD module in Vietnam
- Continue business development activities for customers' capital investment projects

(Million JPY)

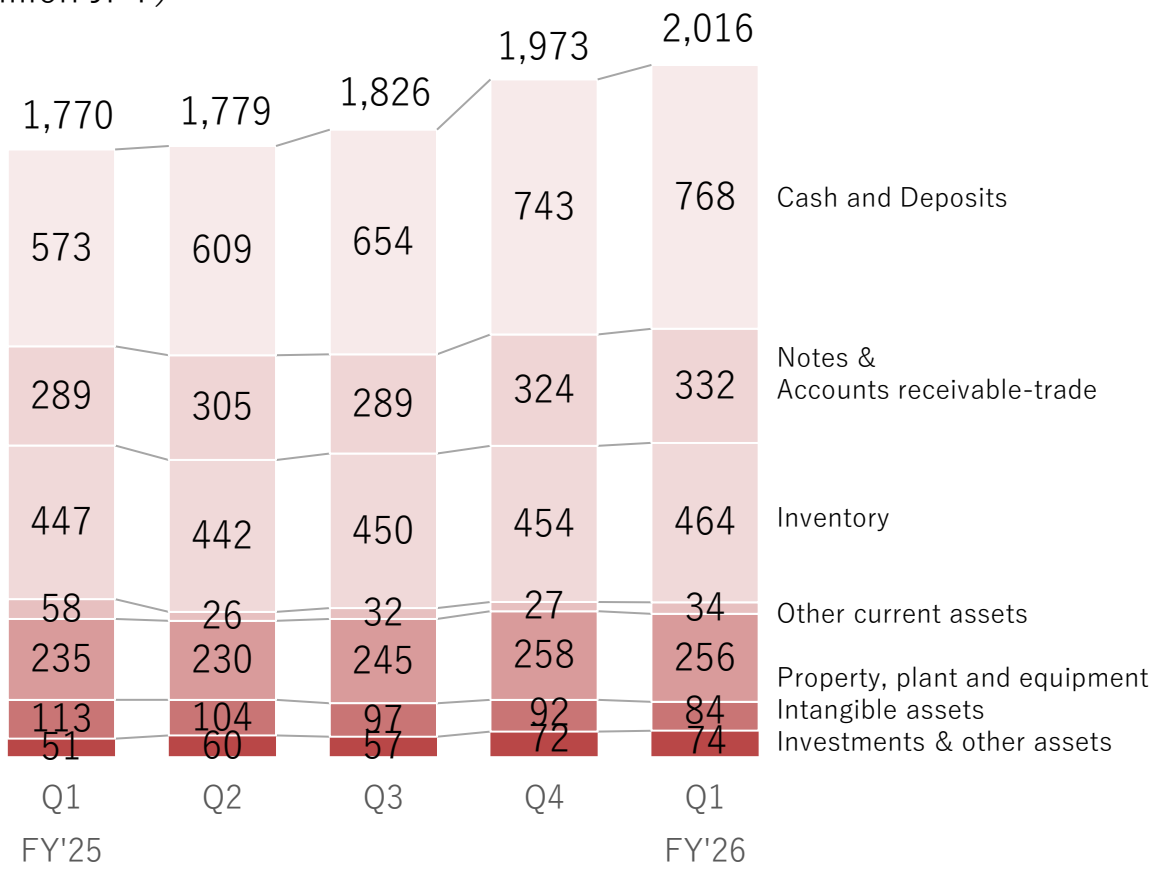


Consolidated balance sheet

- Higher sales increased cash and deposits, securing funds for capital investments in new plants and other facilities while reducing interest-bearing debt
- Inventory increased with higher raw materials, etc., to support rising orders

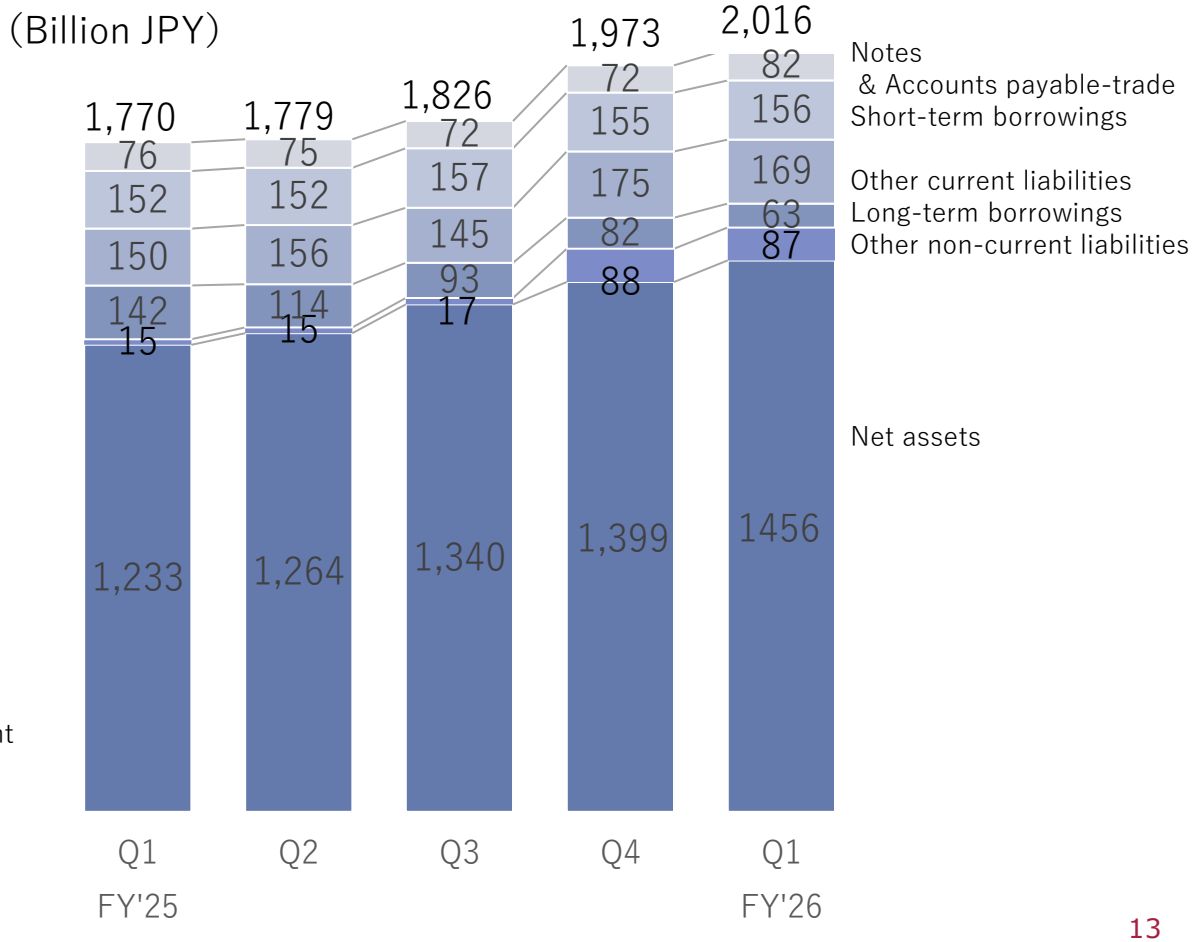
Assets

(Billion JPY)



Liabilities/Net assets

(Billion JPY)



FY2026
Business Forecast

FY2026 Progress against Business Forecasts

- Net sales secured 47.9% of the Q2 forecast, close to the halfway point, though slightly softer than expected
- Strong Semi order growth for two consecutive quarters is expected to support strong sales growth from Q2 onward
- Service/Parts remained strong, supported by growing demand for maintenance parts and services, while efforts continue to increase orders for FPD and Life Science
- All profit items exceeded 50% progress against the first-half forecast, marking a strong start beyond expectations

(Million JPY)

	FY'26 Q1 Achievements	FY'26 Q2 Forecast	Q2 Forecast Progress rate	FY'26 Full-year Forecast	Full-year Forecast Progress rate
Net sales	37,206	77,634	47.9%	159,021	23.4%
Semi	30,239	66,126	45.7%	132,480	22.8%
Analysis device	890	1,613	55.2%	4,225	21.1%
FPD	2,032	4,258	47.7%	10,090	20.1%
Life science	131	340	38.5%	1,588	8.3%
Service/Parts etc.	3,913	5,294	73.9%	10,636	36.8%
Operating Profit	10,230	19,088	53.6%	38,112	26.8%
Ordinary Profit	10,938	19,168	57.1%	38,241	28.6%
Profit attributable to owners of parent	8,210	13,809	59.5%	27,809	29.5%

Future Outlook

Business Environment	● Generative AI accelerated memory investment, particularly in HBM for AI servers, and semiconductor demand expanded beyond expectations ● Semiconductor device manufacturers announced new large-scale capital investment plans ● Orders for transfer systems for advanced semiconductors and advanced packaging are expected to continue rising
Risks	● Rising memory prices, along with supply constraints and longer lead times for some electronic components ● Crude oil price fluctuations amid tensions in the Middle East pose procurement risks, including price increases and supply instability for petroleum-related products such as resins and packaging materials
Actions	● Subsidiaries in Vietnam, China, and other locations increase headcount and reinforce product supply capacity ● Advance material procurement, inventory buildup, and alternative parts and suppliers mitigate delivery risks

Topics

Construction of New Office Building for RORZE IAS

- RORZE IAS plans to construct a new office building to accelerate new product development
  - Engineering office space is planned to expand to support new product development and new inspection demand
  - The laboratory cleanroom is planned to expand to respond quickly to customer needs, including analysis of sample wafers from customers
  - R&D is conducted on analytical methods for new materials used in leading-edge semiconductors

Completion image (Exterior)

Location	Hino City, Tokyo (Near the current head office)
Land Area	3,406.89㎡ (Acquired in Nov. 2025)
Total Floor Area	4,497.25㎡ (3-story office and cleanroom)
Construction Period	September 1, 2026 – December 31, 2027
Planned Completion and Handover (Building)	End of December 2027
Total Investment	2 billion JPY (Planned)

Headquarters R&D Building Construction Plan

- Announcement of **a new R&D building construction** at the head office site
- The new building is planned to include office space for engineers twice the current size, along with a cleanroom for equipment development and testing, including **Class 1** areas, **an anechoic chamber** and **precision measurement rooms**
- Construction is scheduled to begin in July 2027 and be **completed in autumn 2029**

Site Exterior
(Left to Right: Parking Facility / New Headquarters / Existing Headquarters)

Interior
(New Headquarters)

<New Headquarters Building (New Construction)>

Steel structure, 8 stories
Total floor area: approx. 18,000 m²
1F：Entrance hall / Exhibition hall
2F：Development cleanroom /
Collaboration lounge
(Meeting and customer training space)
3F：Innovation Deck (co-creation space)
4～6F：Office floors
7F：Coworking space / Meeting rooms /
Multipurpose space / Reception rooms /
Sky Bridge / Guest & Employee entrance
8F：Storage / Photovoltaic panels, etc.

References

Semi

RORZE

Unit


Atmospheric Robot


Aligner


Load Port

System


EFEM


Vacuum Platform

System


Wafer Sorter


N2 Purge Wafer Stocker

Equipment manufacturers(SPE)

Process equipment

Inspection equipment

End -user

Device manufacturers

Wafer manufacturers

Advanced packaging line

Advanced packaging

Method for connecting chiplet to achieve higher device density and functionality expansion with a smaller footprint

■ Packaging on PCB

Front-end　One chip per wafer

Previous market for RORZE's handling equipment

Back-end　One chip per package

Packaging on PCB with mounter
(Communication between each semiconductor is conducted through the PCB)

■ Packaging on Silicon Wafer

Middle-end　Instead of packaging in back-end,

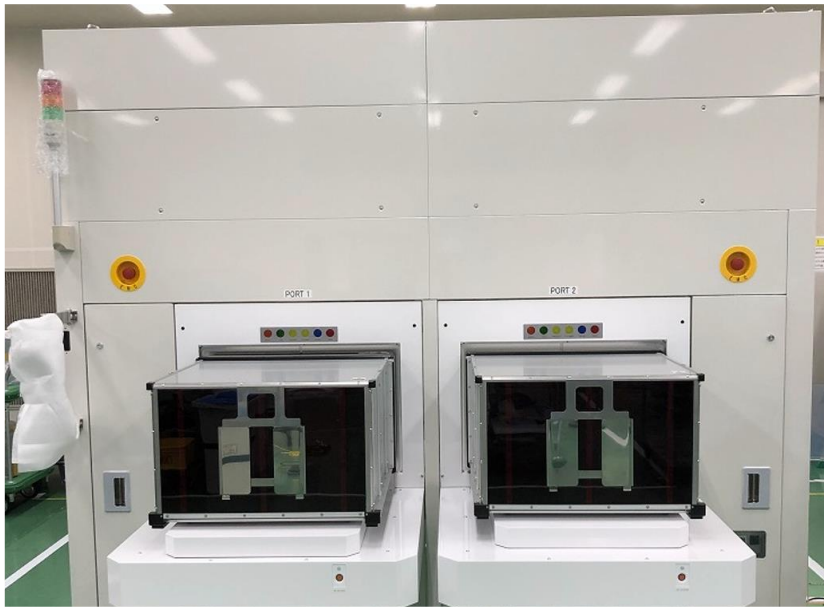
- Forming vertical holes that penetrate silicon by thinning the wafer
  (TSV：Through Silicon Via)
- **Stacking multiple wafers in 3D** on an interposer※

Expands new market, driving demand for RORZE's handling system
(Front-end＋Middle-end)

● Advanced packaging line
- Tape Frame Sorter
- PLP EFEM

※**Interposer**：A substrate that mediates the continuity of circuits on both sides through penetrating electrodes
(such as silicon interposer, glass interposer, and organic interposer)

Advanced packaging line



PLP EFEM

Tape Frame Sorter

Analysis device

RORZE

RORZE IAS INC.

Gas

GED_SEMI

GED_Q

GED

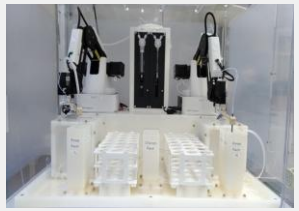
GPD

Chemical solution

ASAS Ⅱ

MSAG

CSI



ASDM

Wafer

Expert

LAGM/Expert LA

Semiconductor industry

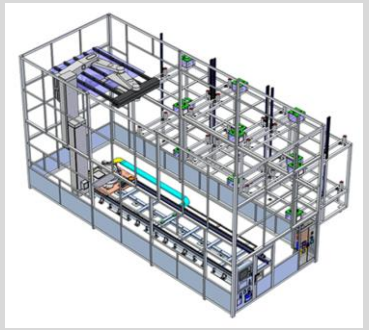
- SPEs
- End-user
  - Device manufacturers
  - Wafer manufacturers

Other industries

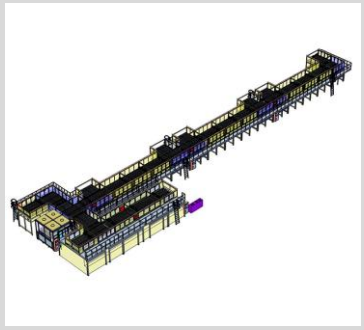
- Research institution
- Environmental measuring
- Instrument manufacturer
- Chemical manufacturer etc.

FPD

RORZE SYSTEMS
(Subsidiary in Korea)



INDEX extra-large substrate transfer system



In-line returnable transfer system

Laser cutting equipment

Display module equipment

Cell type extra-large packing equipment

Front-end :

FPD manufacturers
Glass for FPD manufacturers

Back-end :

FPD manufacturers

Life science

RORZE Lifescience

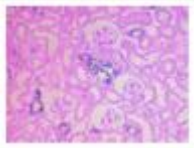
Incubator
SCALE48

CO_2 Incubator with medium exchange function & cell imaging function
CellKeeper® II 48Plus

Mobile robot

Automatic medium exchange system
CellFarm(L)-360™

Scheduling software
Green Button Go™ ※
(※Product of Biosero)



tissue staining and gene function analysis
GenoStaff

Drug discovery, Regenerative medicine (universities, pharmaceutical companies)


RORZE